

TSM10N80 Taiwan Semiconductor

N-Channel Power MOSFET

800V, 9.5A, 1.05Ω

FEATURES

- Low R_{DS(ON)} 1.05Ω (Max.)
- Low gate charge typical @ 53nC (Typ.)
- Improve dV/dt capability
- Pb-free plating
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEE 2002/96/EC

TO-220

Halogen-free according to IEC 61249-2-21
 definition

APPLICATION

- Power Supply
- Lighting

ITO-220

KEY PERFORMANCE PARAMETERS				
PARAMETER	VALUE	UNIT		
V _{DS}	800	V		
R _{DS(on)} (max)	1.05	Ω		
Qg	53	nC		



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	TO-220	ITO-220	UNIT
Drain-Source Voltage		V _{DS}	800		V
Gate-Source Voltage		V_{GS}	±30		V
Continuous Drain Current (Note 1)	「 _C = 25°C	I_	9.5 5.7		А
	Γ _C = 100°C	ID			
Pulsed Drain Current (Note 2)		I _{DM}	38		А
Total Power Dissipation @ $T_c = 25^{\circ}C$		P _{DTOT}	290	48	W
Single Pulsed Avalanche Energy		E _{AS}	267		mJ
Single Pulsed Avalanche Current		I _{AS}	10		А
Operating Junction and Storage Temperature Range		T _J , T _{STG}	- 55 to +150		°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TO-220	ITO-220	UNIT
Junction to Case Thermal Resistance	R _{eJC}	0.43	2.6	°C/W
Junction to Ambient Thermal Resistance	R _{eJA}	62.5		°C/W

Notes: $R_{\Theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case thermal reference is defined at the solder mounting surface of the drain pins. $R_{\Theta JA}$ is guaranteed by design while $R_{\Theta CA}$ is determined by the user's board design. $R_{\Theta JA}$ shown below for single device operation on FR-4 PCB with minimum recommended footprint in still air.



TSM10N80

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PARAMETER	CONDITIONS	SYMBOL	MIN	ТҮР	MAX	UNIT
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Static (Note 3)	T	Γ		[
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250 \mu A$	BV _{DSS}	800			V
Gate Threshold Voltage	V_{DS} = V_{GS} , I_D = 250 μ A	$V_{GS(TH)}$	2.0		4.0	V
Gate Body Leakage	V_{GS} = ±30, V_{DS} = 0V	I _{GSS}			±100	nA
Zero Gate Voltage Drain Current	V_{DS} = 800V, V_{GS} = 0V	I _{DSS}			10	μA
Drain-Source On-State Resistance	V_{GS} = 10V, I_{D} = 4.75A	$R_{DS(on)}$		0.9	1.05	Ω
Forward Transconductance	V_{DS} = 30V, I_{D} = 4.75A	g _{fs}		6.3		S
Dynamic ^(Note 4)						
Total Gate Charge		Qg	/	53		
Gate-Source Charge	$V_{DS} = 640V, I_D = 9.5A,$	Q_gs		10		nC
Gate-Drain Charge	V _{GS} = 10V	Q_gd		23		
Input Capacitance		C _{iss}		2336		
Output Capacitance	V _{DS} = 25V, V _{GS} = 0V, f = 1.0MHz	Coss		214		pF
Reverse Transfer Capacitance		C _{rss}		29		
Switching (Note 5)						
Turn-On Delay Time		t _{d(on)}		63		
Turn-On Rise Time	V _{DS} = 400V, V _{GS} = 10V	t _r		62		
Turn-Off Delay Time	R _G = 25Ω, I _D = 9.5A	t _{d(off)}		256		ns
Turn-Off Fall Time		t _f		72		
Source-Drain Diode (Note 3)	0					
Forward On Voltage	I _S = 9.5A, V _{GS} = 0V	V_{SD}			1.5	V
Reverse Recovery Time	I _S = 9.5A, V _{GS} = 0V	t _{rr}		450		ns
Reverse Recovery Charge	dl _⊧ /dt = 100A/µs	Q _{rr}		5.3		μC

Notes:

Current limited by package. 1.

- Pulse width limited by the maximum junction temperature.
 L = 5mH, I_{AS} = 10A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C 100% Eas Test Condition: L = 5mH, I_{AS} = 5A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
- 4. Pulse test: $PW \leq 300\mu s$, duty cycle $\leq 2\%$.
- For DESIGN AID ONLY, not subject to production testing. 5.
- 6. Switching time is essentially independent of operating temperature.

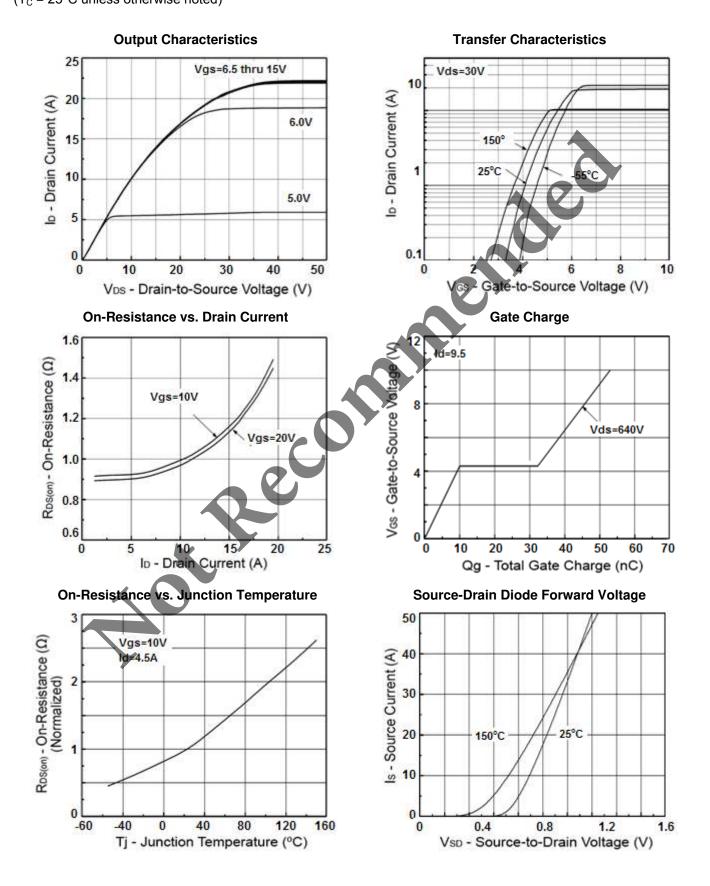


ORDERING INFORMATION

PART NO.	PACKAGE	PACKING	
TSM10N80CZ C0G	TO-220	50pcs / Tube	
TSM10N80CI C0G	ITO-220	50pcs / Tube	



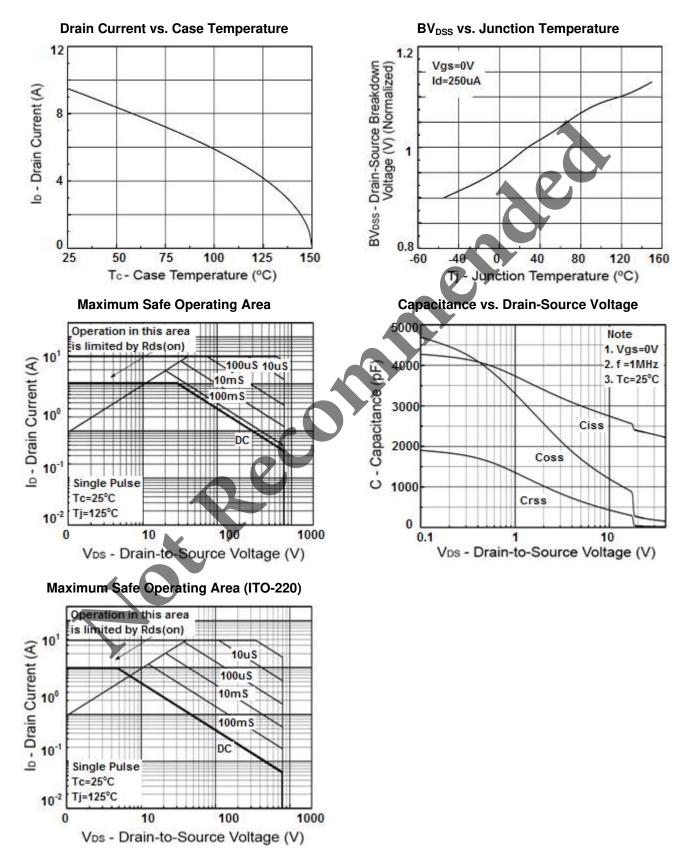
CHARACTERISTICS CURVES $(T_c = 25^{\circ}C \text{ unless otherwise noted})$





CHARACTERISTICS CURVES

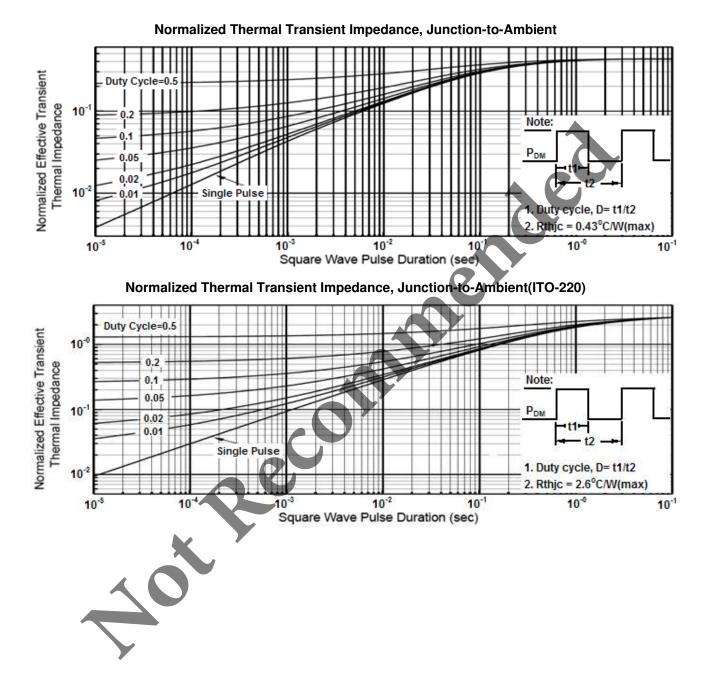
(T_C = 25°C unless otherwise noted)





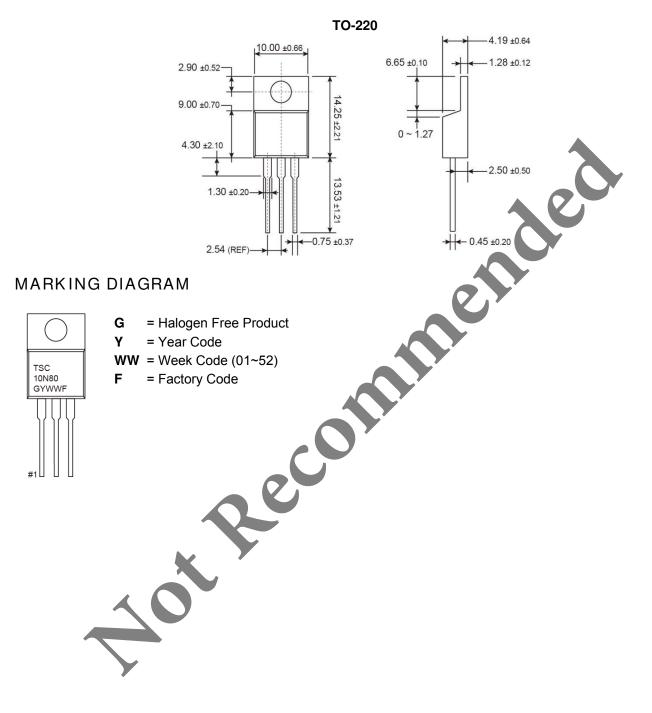
CHARACTERISTICS CURVES

($T_c = 25^{\circ}C$ unless otherwise noted)





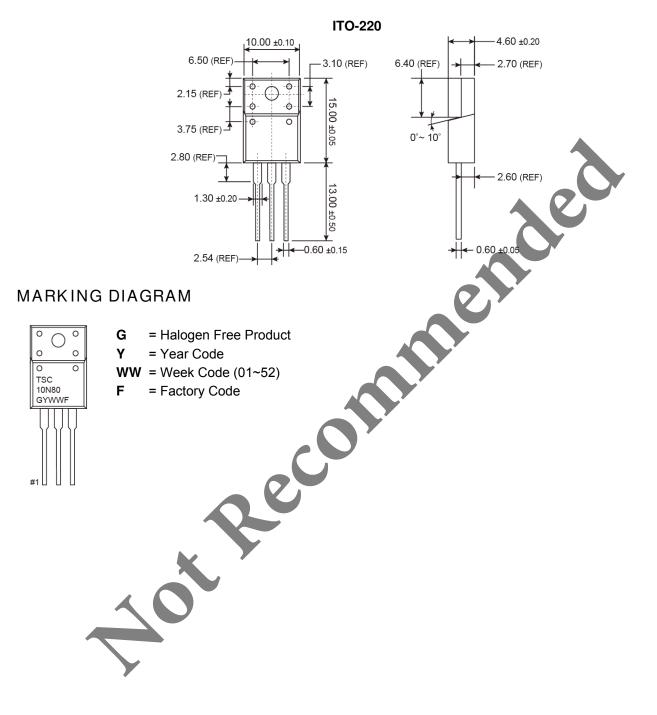
PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)





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PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)







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